



3N80

Power MOSFET

3 Amps, 800 Volts N-CHANNEL POWER MOSFET

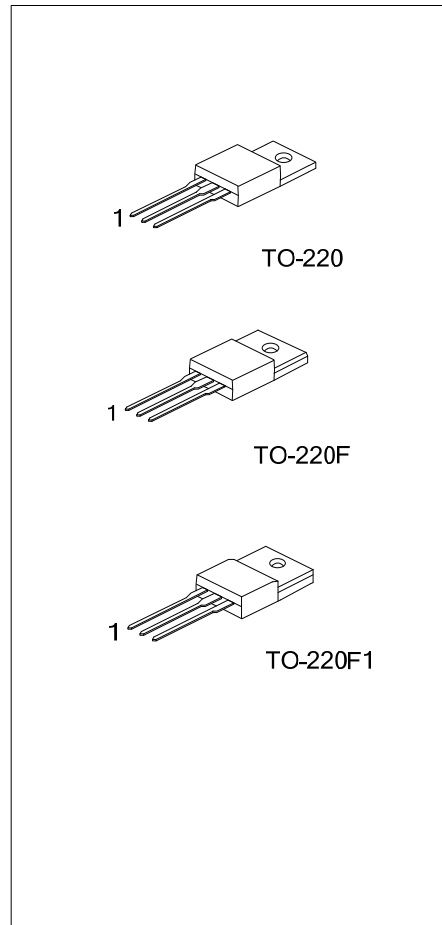
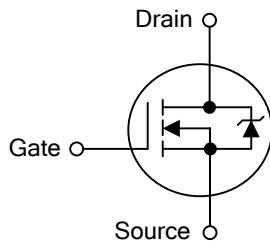
■ DESCRIPTION

The UTC **3N80** provide excellent $R_{DS(ON)}$, low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

■ FEATURES

- * $R_{DS(ON)}=3.8\Omega @V_{GS}=10V$
- * Ultra Low Gate Charge (typical 19 nC)
- * Low Reverse Transfer Capacitance ($C_{RSS} = \text{Typical } 11 \text{ pF}$)
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, High Ruggedness

■ SYMBOL



■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
3N80L-TA3-T	3N80G-TA3-T	TO-220	G	D	S	Tube
3N80L-TF3-T	3N80G-TF3-T	TO-220F	G	D	S	Tube
3N80L-TF1-T	3N80G-TF1-T	TO-220F1	G	D	S	Tube

<p>3N80L-TA3-T</p> <p>(1)Packing Type</p> <p>(2)Package Type</p> <p>(3)Lead Free</p>	<p>(1) T: Tube</p> <p>(2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1</p> <p>(3) G: Halogen Free, L: Lead Free</p>
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■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage (V _{GS} =0V)	V _{DSS}	800	V
Drain-Gate Voltage (R _G =20kΩ)	V _{DGR}	800	V
Gate-Source Voltage	V _{GSS}	±30	V
Gate-Source Breakdown Voltage (I _{GS} =±1mA)	BV _{GSO}	30(MIN)	V
Insulation Withstand Voltage (DC)	V _{ISO}	2500	V
Avalanche Current (Note 2)	I _{AR}	3	A
Continuous Drain Current	I _D	3	A
Pulsed Drain Current	I _{DM}	10	A
Single Pulse Avalanche Energy (Note 3)	E _{AS}	170	mJ
Peak Diode Recovery dv/dt (Note 4)	dv/dt	4.5	V/ns
Power Dissipation	TO-220	70	W
	TO-220F/ TO-220F1	25	
Junction Temperature	T _J	+150	°C
Storage Temperature	T _{STG}	-55 ~ +150	°C

Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Pulse width limited by T_{J(MAX)}

3. starting T_J=25 °C, I_D=I_{AR}, V_{DD}=50V

4. I_{SD} ≤ 2.5A, di/dt ≤ 200A/μs, V_{DD} ≤ BV_{DSS}, T_J ≤ T_{J(MAX)}.

■ THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT
Junction to Ambient	TO-220	62.5	°C/W
	TO-220F/ TO-220F1	62.5	
Junction to Case	TO-220	1.78	°C/W
	TO-220F/ TO-220F1	5	

■ ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	800			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =800V, V _{GS} =0V			1	μA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±30V, V _{DS} =0V			±10	μA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250μA	3	3.75	4.5	V
Static Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =1.5A		3.8	4.5	Ω
Forward Transconductance (Note 1)	g _{FS}	V _{DS} =15V, I _D =1.5A		2.1		S
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ISS}	V _{DS} =25V, V _{GS} =0V, f=1MHZ		485		pF
Output Capacitance	C _{OSS}			57		pF
Reverse Transfer Capacitance	C _{RSS}			11		pF
Equivalent Output Capacitance (Note 2)	C _{OSS(EQ)}	V _{GS} =0V, V _{DS} =0V~640V		22		pF
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{D(ON)}	V _{DD} =400V, I _D =3 A, R _G =4.7Ω V _{GS} =10V		17		ns
Turn-On Rise Time	t _R			27		ns
Turn-Off Delay Time	t _{D(OFF)}			36		ns
Turn-Off Fall Time	t _F			40		ns
Total Gate Charge	Q _G	V _{DD} =640V, I _D =3A, V _{GS} =10V		19		nC
Gate-Source Charge	Q _{GS}			3.2		nC
Gate-Drain Charge	Q _{DD}			10.8		nC

■ ELECTRICAL CHARACTERISTICS(Cont.)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Diode Forward Voltage(Note 1)	V_{SD}	$I_{SD}=3A, V_{GS}=0V$			1.6	V
Source-Drain Current	I_{SD}				2.5	A
Source-Drain Current (Pulsed)	I_{SDM}				10	A
Reverse Recovery Current	I_{RRM}	$I_{SD}=3A, di/dt=100A/\mu s,$ $V_{DD}=50V, T_J=25^\circ C$		8.4		A
Body Diode Reverse Recovery Time	t_{RR}			384		ns
Body Diode Reverse Recovery Charge	Q_{RR}			1600		nC

Note: 1.Pulse width=300 μ s, Duty cycle \leq 1.5%

2. $C_{OSS(EQ)}$ is defined as constant equivalent capacitance giving the same charging time as C_{OSS} when V_{DS} increases from 0 to 80% V_{DSS} .

■ TEST CIRCUITS AND WAVEFORMS

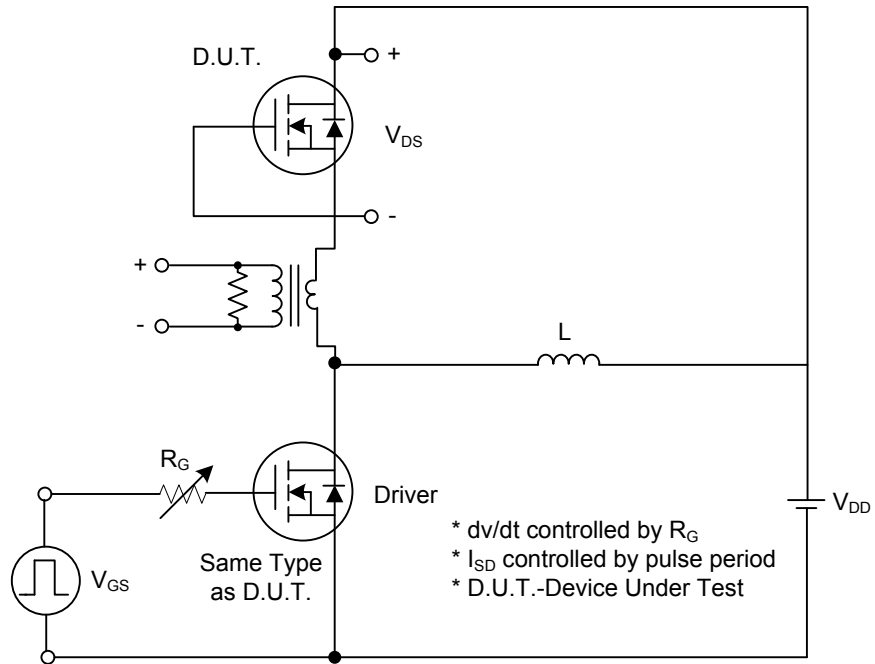


Fig. 1A Peak Diode Recovery dv/dt Test Circuit

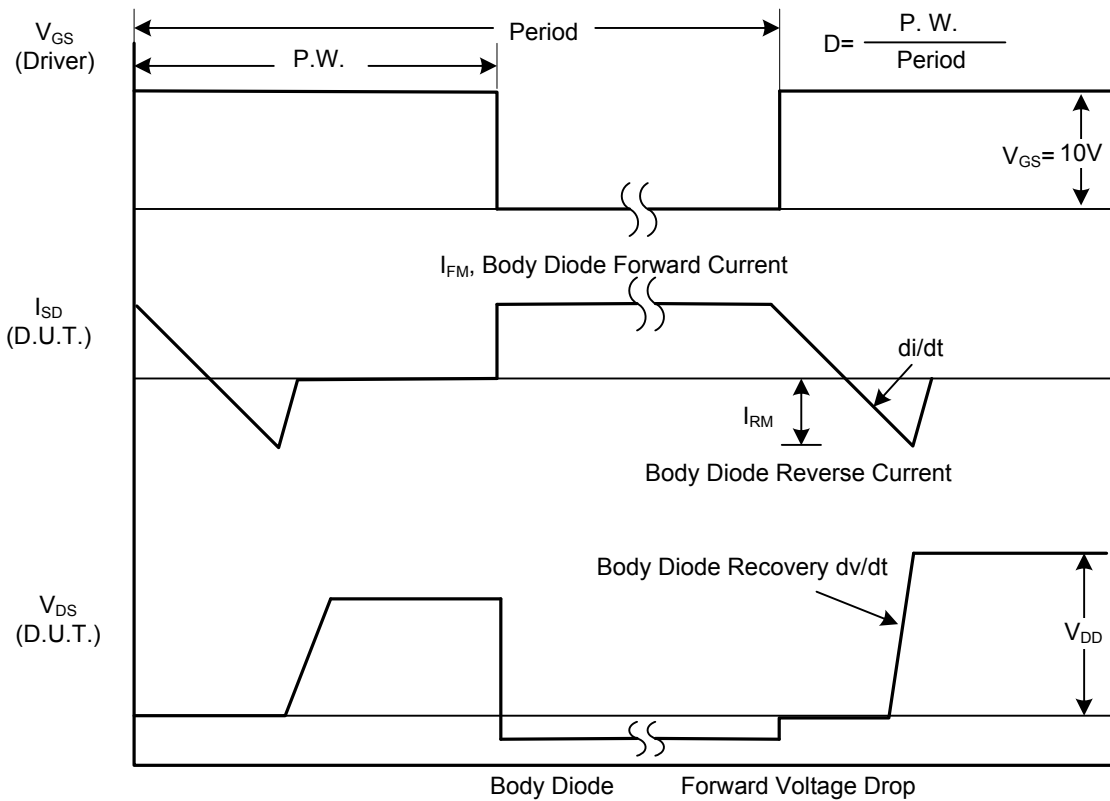


Fig. 1B Peak Diode Recovery dv/dt Waveforms

■ TEST CIRCUITS AND WAVEFORMS (Cont.)

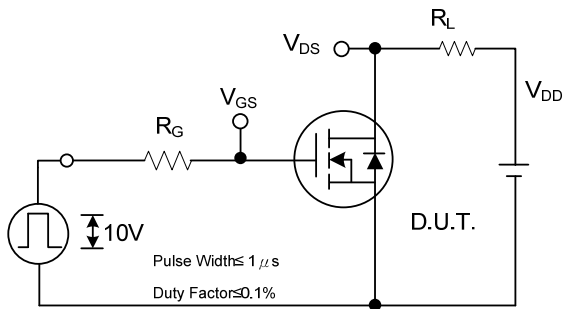


Fig. 2A Switching Test Circuit

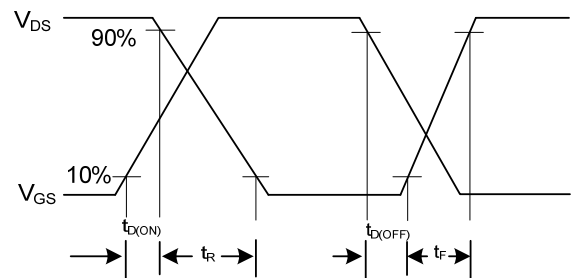


Fig. 2B Switching Waveforms

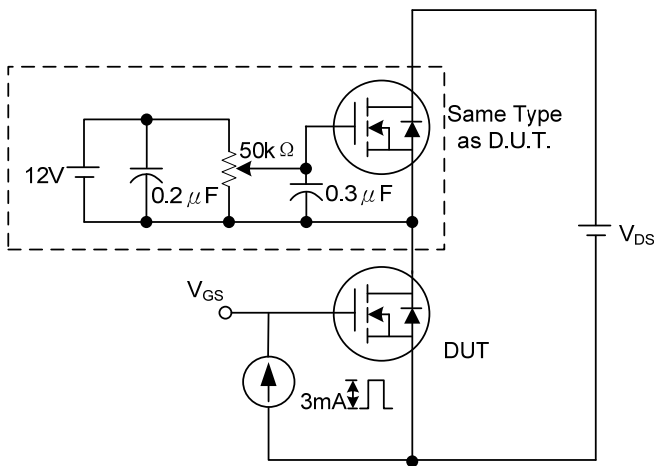


Fig. 3A Gate Charge Test Circuit

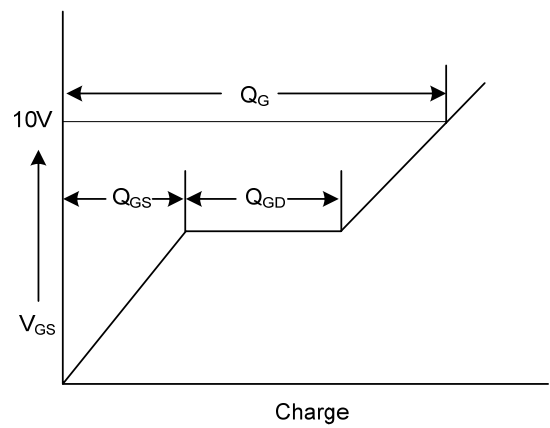


Fig. 3B Gate Charge Waveform

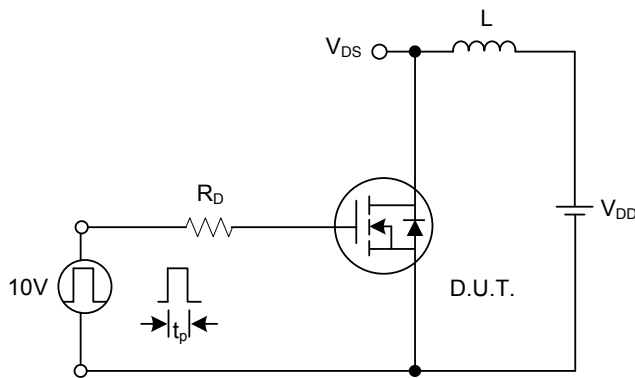


Fig. 4A Unclamped Inductive Switching Test Circuit

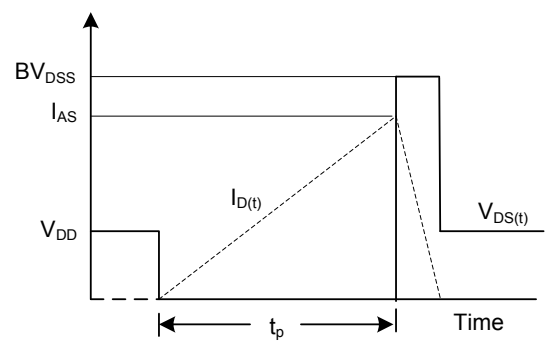
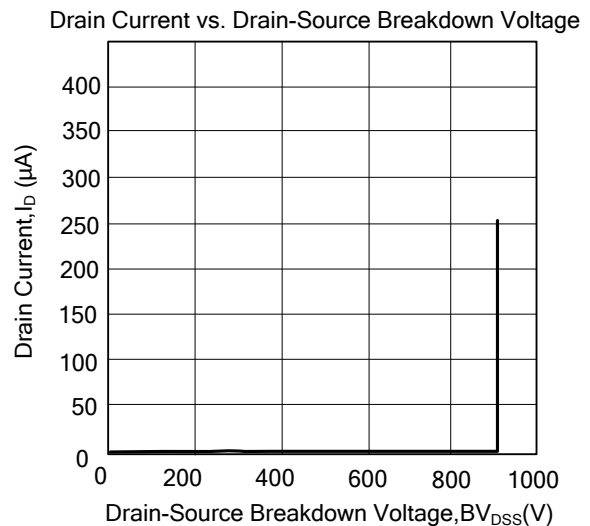
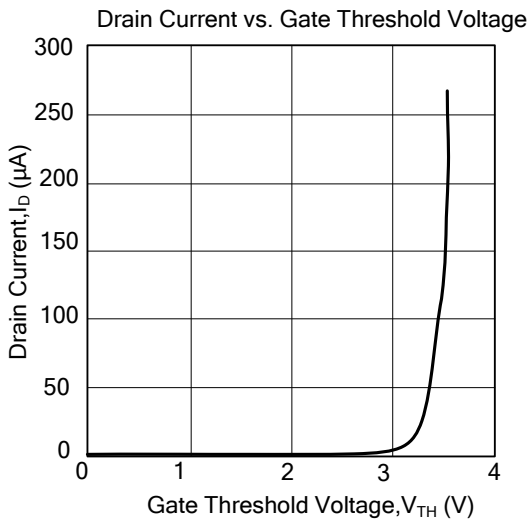
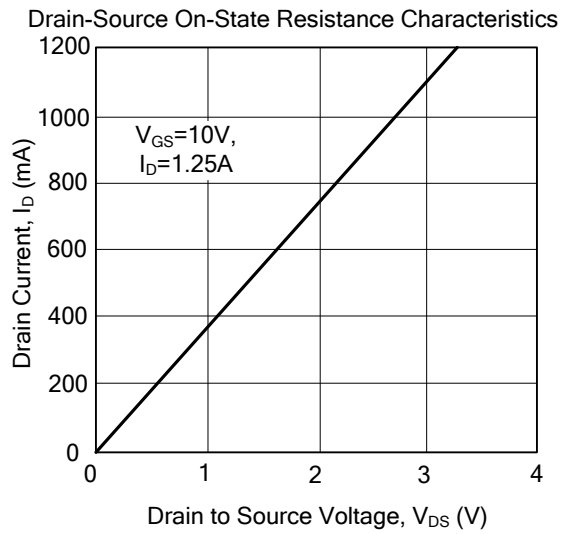
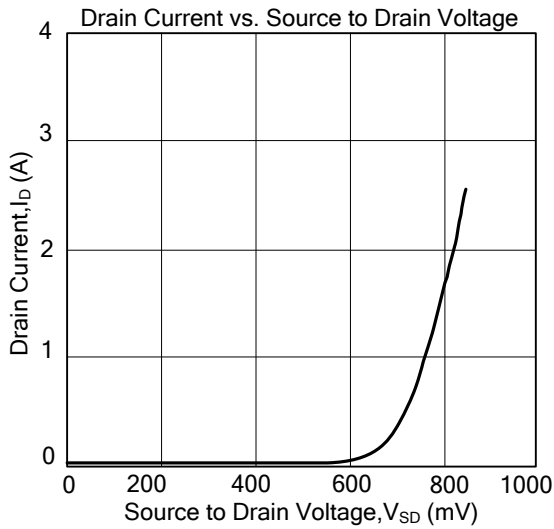


Fig. 4B Unclamped Inductive Switching Waveforms

TYPICAL CHARACTERISTICS



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